## 34-Channel Symmetric Row Driver

## **Ordering Information**

	Package Options									
Device	44 J-Lead Quad Ceramic Chip Carrier	44 J-Lead Quad 44 J-Lead Quad		44 J-Lead Quad Ceramic Chip Carrier (MIL-Std-883 Processed*)						
HV7022-C	HV7022DJ-C	HV7022PJ-C	HV7022X-C	RBHV7022DJ-C						

<sup>\*</sup>For Hi-Rel process flows, refer to page 5-3 of the databook.

### **Features**

- ☐ Processed with HVCMOS® technology
- Symmetric row drive (reduces latent imaging in ACTFEL displays)
- Output voltages up to 230V
- Low-power level shifting
- ☐ Source/Sink current 70mA (min.)
- Shift register speed 4MHz
- ☐ Pin-programmable shift direction
- → 44-lead plastic & ceramic surface-mount packages
- Hi-Rel processing available

## **Absolute Maximum Ratings**

Supply voltage, V <sub>DD</sub> <sup>1</sup>	-0.3V to +15V			
Supply voltage, V <sub>PP</sub> <sup>1</sup>			-0.3V	to +250V
Logic input levels <sup>1</sup>	-0.3V to V <sub>DD</sub> +0.3V			
Ground current <sup>2</sup>				1.5A
Continuous total power dissipati	ion <sup>3</sup> :	Plastic Ceram		1200mW 1500mW
Operating temperature range	Plas Cera	stic amic		to +85°C to 125°C
Storage temperature range			-65°C t	o +150°C
Lead temperature 1.6mm (1/16 from case for 10 seconds	inch)			260°C

#### Notes:

- 1. All voltages are referenced to GND.
- 2. Duty cycle is limited by the total power dissipated in the package.
- For operation above 25°C ambient derate linearly to maximum operating temperature at 25mW/°C for plastic and at 15mW/°C for ceramic.

## **General Description**

The HV7022-C is a low-voltage serial to high-voltage parallel converter with push-pull outputs. It is especially suited for use as a symmetric row driver in AC thin-film electroluminescent (ACTFEL) displays. The HV70 offers 34 output lines, a direction (DIR) pin to give CW or CCW shift register loading, output enable (OE), and polarity (POL) control. After DATA INPUT is entered (on the falling edge of CLOCK), a logic high will cause the output to swing to  $V_{PP}$  if POL is high, or to GND if POL is low.

For Detailed circuit and application information, please refer to Application Note AN-H3.

#### 02/96/022

Supertex Inc. does not recommend the use of its products in life support applications and will not knowingly sell its products for use in such applications unless it receives an adequate "products liability indemnification insurance agreement." Supertex does not assume responsibility for use of devices described and limits its liability to the replacement of devices determined to be defective due to workmanship. No responsibility is assumed for possible omissions or inaccuracies. Circuitry and specifications are subject to change without notice. For the latest product specifications, refer to the Supertex website: http://www.supertex.com. For complete liability information on all Supertex products, refer to the most current databook or to the Legal/Disclaimer page on the Supertex website.

## **Electrical Characteristics**

(over recommended operating conditions of  $V_{DD} = 12V$ ,  $T_A = 25$ °C and  $V_{PP} = 230V$  unless otherwise noted)

### **DC Characteristics**

Symbol	Parameter	Min	Max	Units	Conditions	
I <sub>DD</sub>	V <sub>DD</sub> supply current			10	mA	f <sub>CLK</sub> = 4MHz
I <sub>PP</sub>	High voltage supply cui	rrent		4	mA	1 Output high <sup>1</sup>
				100	μΑ	All Outputs low or High-Z
				750	μА	All Outputs low or High-Z (125°C)
I <sub>DDQ</sub>	Quiescent V <sub>DD</sub> supply of		100	μΑ	All V <sub>IN</sub> = GND or V <sub>DD</sub>	
V <sub>OH</sub>	High-level output	HV <sub>OUT</sub>	195		V	I <sub>O</sub> = -70mA (-50mA) <sup>2</sup>
		Data out	11		V	I <sub>O</sub> = -500μA
V <sub>OL</sub>	Low-level output	HV <sub>OUT</sub>		30	V	I <sub>O</sub> = 70mA (+50mA) <sup>2</sup>
		Data out		1	V	I <sub>O</sub> = 500μA
I <sub>IH</sub>	High-level logic input cu		1	μΑ	V <sub>IH</sub> = 12V	
I <sub>IL</sub>	Low-level logic input cu	irrent		-1	μΑ	V <sub>IL</sub> = 0V

#### Notes:

- 1. The total number of ON outputs times the duty cycle must not exceed the allowable package power disspation.
- 2. Over military temperature range (-55°C to 125°C).

## AC Characteristics $(V_{DD} = 12V, T_C = 25^{\circ}C)$

Symbol	Parameter	Min	Max	Units	Conditions
f <sub>CLK</sub>	Clock frequency		4	MHz	
t <sub>W</sub>	Pulse duration clock high or low	125		ns	
t <sub>SUD</sub>	Data set-up time before falling clock	100		ns	
t <sub>HD</sub>	Data hold time after falling clock	100		ns	
t <sub>SUC</sub>	Setup time clock low before V <sub>PP</sub> ↑ or GND↓	300		ns	
t <sub>SUE</sub>	Setup time enable high before V <sub>PP</sub> ↑ or GND↓	300		ns	
t <sub>SUP</sub>	Setup time polarity high or low before V <sub>PP</sub> ↑ or GND↓	300		ns	
t <sub>HC</sub>	Hold time clock high after V <sub>PP</sub> ↑ or GND↓	500		ns	
t <sub>HE</sub>	Hold time enable high after V <sub>PP</sub> ↑ or GND↓	300		ns	
t <sub>HP</sub>	Hold time polarity high or low after V <sub>PP</sub> ↑ or GND↓	300		ns	
t <sub>DHL</sub>	Delay time high to low level output from clock		150	ns	C <sub>L</sub> = 10pF
t <sub>DLH</sub>	Delay time low to high level output from clock		200	ns	C <sub>L</sub> = 10pF
t <sub>THL</sub>	Transition time high to low level serial output		200	ns	C <sub>L</sub> = 15pF
t <sub>TLH</sub>	Transition time low to high level serial output		100	ns	C <sub>L</sub> = 15pF
t <sub>ONH</sub>	High level turn-on time Q outputs from enable		500	ns	$I_{O} = -50 \text{ mA}, V_{OH} = 195 \text{V}$ $R_{L} = 2 \text{ k}\Omega \text{ to } 95 \text{V}$
t <sub>ONL</sub>	Low level turn-on time Q outputs from enable		500	ns	$I_O = 50 \text{ mA}, V_{OH} = 130 \text{V}$ $R_L = 2 \text{ k}\Omega \text{ to } 30 \text{V}$
t <sub>OFFH</sub>	High level turn-off time Q outputs from enable		1000	ns	$I_O = -50 \text{ mA}, V_{OH} = 195 \text{V}$ $R_L = 2 \text{ k}\Omega \text{ to } 95 \text{V}$
t <sub>OFFL</sub>	Low level turn-off time Q outputs from enable		500	ns	$I_{O} = 50 \text{ mA}, V_{OH} = 130 \text{V}$ $R_{L} = 2 \text{ k}\Omega \text{ to } 30 \text{V}$
	Slew rate, V <sub>PP</sub> or GND		45	V/µs	With one active output driving a 4.7 nF load to V <sub>PP</sub> or GND

# **Recommended Operating Conditions**

Symbol	Paramete	Min	Max	Units	
V <sub>DD</sub>	Logic supply voltage		10.8	13.2	V
V <sub>PP</sub>	High voltage supply			230	V
V <sub>IH</sub>	High-level input voltage	V <sub>DD</sub> = 10.8V	8.1		V
		V <sub>DD</sub> = 13.2V	9.9		
V <sub>IL</sub>	Low-level input voltage	V <sub>DD</sub> = 10.8V		2.7	V
		V <sub>DD</sub> = 13.2V		3.3	
f <sub>CLK</sub>	Clock frequency			4	MHz
T <sub>A</sub>	Operating free-air temperature	Plastic	-40	+85	°C
		Ceramic	-55	+125	°C
I <sub>OD</sub>	Allowable pulse current through out	Allowable pulse current through output diodes			

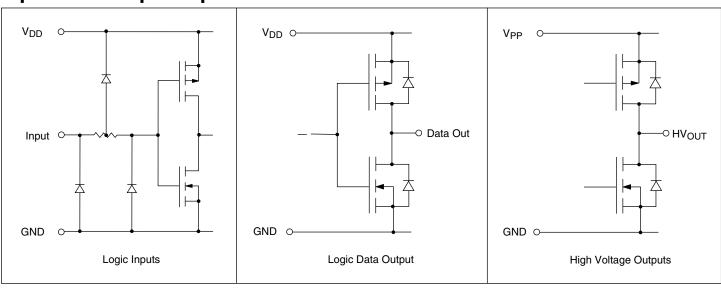
#### Note:

Power-up sequence should be the following:

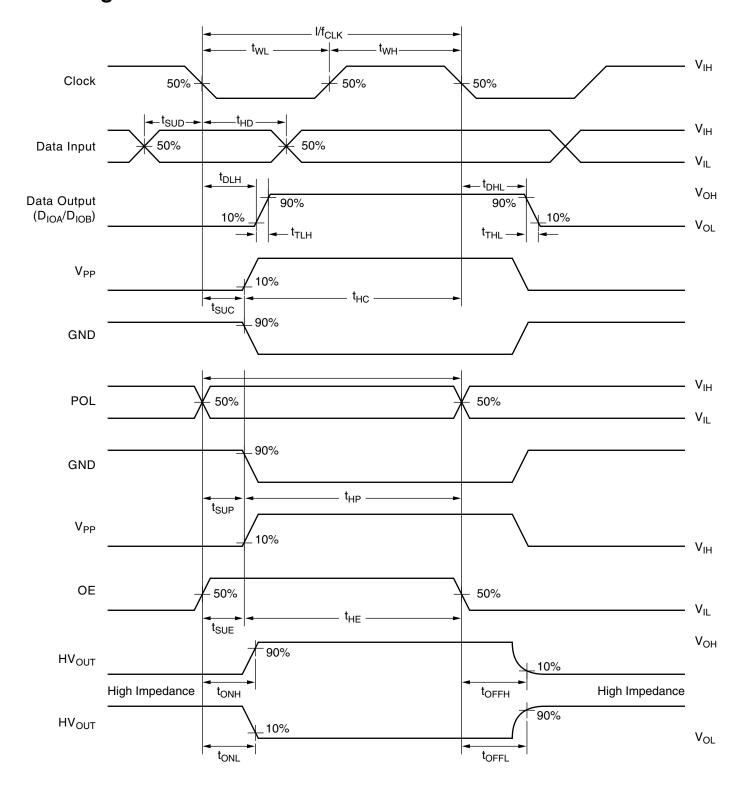
- 1. Connect ground.
- 2. Apply  $V_{DD}$ .
- 3. Set all inputs (Data, CLK, Enable, etc.) to a known state.
- 4. Apply V<sub>PP</sub>.
- 5. The  $V_{PP}$  should not drop below  $V_{DD}$  or float during operation.

Power-down sequence should be the reverse of the above.

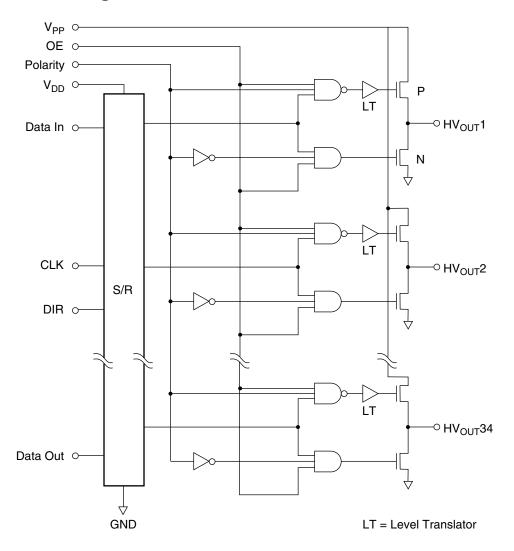
# **Input and Output Equivalent Circuits**



# **Switching Waveforms**



# **Functional Block Diagram**



## **Function Table**

			Inputs		Outputs				
I/O Relations	CLK	DIR	Data	POL	OE	Shift Reg	HV Outputs	Data Out	
O/P HIGH	Х	Х	Н	Н	Н	*	Н		
O/P OFF	Х	Х	L	Н	Н	*	HIGH-Z	*	
O/P LOW	Х	Х	Н	L	Н	*	L	*	
O/P OFF	Х	Х	L	L	Н	*	HIGH-Z	*	
O/P OFF	X	X	X	Х	L	*	All O/P HIGH-Z	*	
Load S/R,	↓	L	Х	Х	Х	$Q_n \rightarrow Q_{n+1}$	*	Q <sub>34</sub>	
set DIR	<b>↓</b>	Н	Х	Х	Х	$Q_n \rightarrow Q_{n-1}$	*	$Q_{_1}$	
	No ↓	Х	Х	Х	Х	*	No Change	No Change	

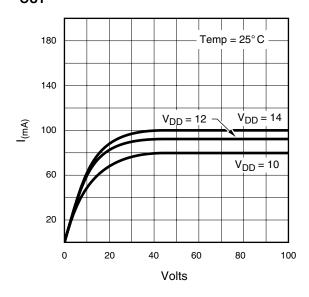
#### Notes:

 $H = logic \ high \ level, \ L = logic \ low \ level, \ X = irrelevant, \ \downarrow = high-to-low \ transition,$ 

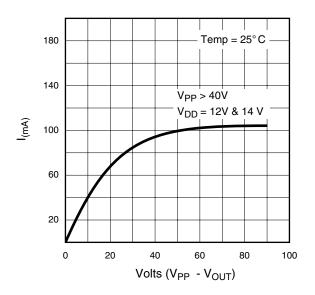
 $Q_1 = HV_{OUT} 1$ ,  $Q_n = HV_{OUT}(n)$ , etc.

<sup>\* =</sup> dependent on previous state and whether an O/P or S/R command occured.

# **HV<sub>OUT</sub> Characteristics**



Output N-Channel Characteristics through FET



Output P-Channel Characteristics through FET

## **Pin Configurations**

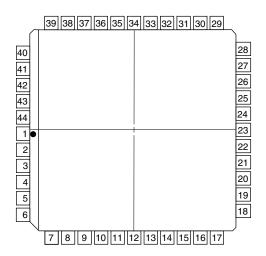
### HV70 44 Pin J-Lead Package

Pin	Function	Pin	Function
1	HV <sub>OUT</sub> 18/17	23	DIR
2	HV <sub>OUT</sub> 17/18	24	$V_{_{ m DD}}$
3	HV <sub>OUT</sub> 16/19	25	Polarity
4	HV <sub>OUT</sub> 15/20	26	Data In
5	HV <sub>OUT</sub> 14/21	27	$V_{pp}$
6	HV <sub>OUT</sub> 13/22	28	N/C
7	HV <sub>OUT</sub> 12/23	29	HV <sub>OUT</sub> 34/1
8	HV <sub>OUT</sub> 11/24	30	HV <sub>OUT</sub> 33/2
9	HV <sub>OUT</sub> 10/25	31	HV <sub>OUT</sub> 32/3
10	HV <sub>OUT</sub> 9/26	32	HV <sub>OUT</sub> 31/4
11	HV <sub>OUT</sub> 8/27	33	HV <sub>OUT</sub> 30/5
12	HV <sub>OUT</sub> 7/28	34	HV <sub>OUT</sub> 29/6
13	HV <sub>OUT</sub> 6/29	35	HV <sub>OUT</sub> 28/7
14	HV <sub>OUT</sub> 5/30	36	HV <sub>OUT</sub> 27/8
15	HV <sub>OUT</sub> 4/31	37	HV <sub>OUT</sub> 26/9
16	HV <sub>OUT</sub> 3/32	38	HV <sub>OUT</sub> 25/10
17	HV <sub>OUT</sub> 2/33	39	HV <sub>OUT</sub> 24/11
18	HV <sub>OUT</sub> 1/34	40	HV <sub>OUT</sub> 23/12
19	Data Out	41	HV <sub>OUT</sub> 22/13
20	Output Enable	42	HV <sub>OUT</sub> 21/14
21	Clock	43	HV <sub>OUT</sub> 20/15
22	GND	44	HV <sub>OUT</sub> 19/16

#### Note:

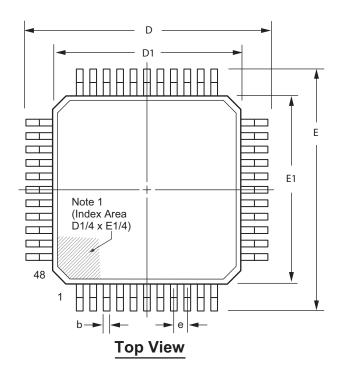
Pin designation for DIR L/H  $Example: For DIR = L, pin 1 is HV_{OUT} 18$   $For DIR = H, pin 1 is HV_{OUT} 17$ 

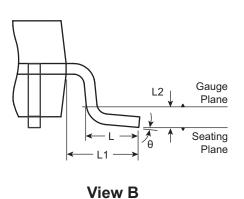
# **Package Outline**

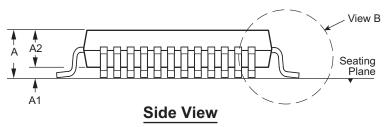


top view
44-pin J-Lead Package

## 44-Lead PQFP Package Outline (PG)







**Note 1:**A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier may be either a mold, or an embedded metal or marked feature.

Symb	ol	Α	A1	A2	b	D	D1	E	E1	е	L	L1	L2	θ	θ1			
Dimension (mm)	MIN	-	0.25	1.95	0.30	13.65	9.80	13.65	9.80	0.73		0.73	0.73	0.73		0.05	3.50	5°
	NOM	-	-	2.00	-	13.90	10.00	13.90	10.00	0.80 BSC	1 0 88 1	1.95   0.25 REF   BSC	0.25 BSC	-	-			
	MAX	2.45	-	2.10	0.45	14.15	10.20	14.15	10.20	ВОО		IXLI	Воо	7°	16°			

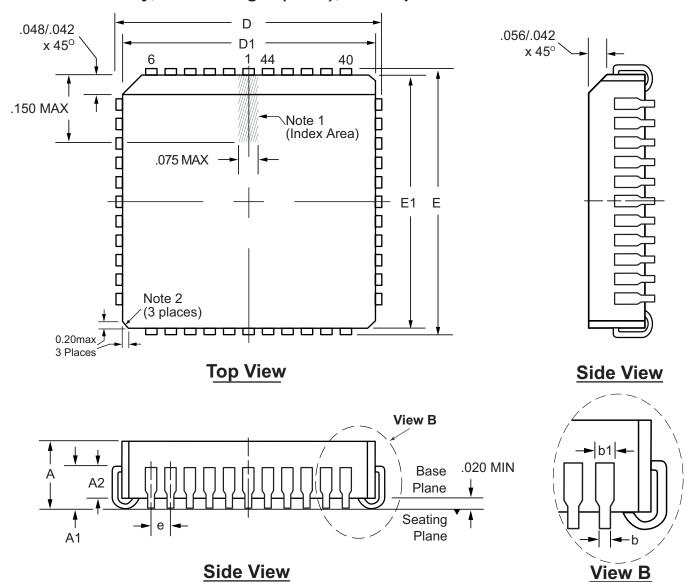
JEDEC Registration M0-112, Variation AA-2, Issue B, Sep.1995.

**Supertex inc.** does not recommend the use of its products in life support applications, and will not knowingly sell its products for use in such applications, unless it receives an adequate "product liability indemnification insurance agreement". **Supertex** does not assume responsibility for use of devices described and limits its liability to the replacement of the devices determined defective due to workmanship. No responsibility is assumed for possible omissions or inaccuracies. Circuitry and specifications are subject to change without notice. For the latest product specifications, refer to the **Supertex** website: http://www.supertex.com.

©2007 **Supertex inc.** All rights reserved. Unauthorized use or reproduction is prohibited.

## 44-Lead PLCC Package Outline (PJ)

.653x.653in body, .180in height (max.), .050in pitch



#### Note:

1. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier may be either a mold, or an embedded metal or marked feature. 2. Exact shape of this feature is optional.

Sym	bol	Α	A1	A2	b	b1	D	D1	E	E1	е
Dimension (inches)	MIN	.165	.090	.062	.013	.026	.685	.650	.685	.650	0.50
	NOM	.172	.105	-	-	-	.690	.653	.690	.653	.050 BSC
(mones)	MAX	.180	.120	.083	.021	.036	.695	.656	.695	.656	ВОО

JEDEC Registration MS-018, Variation AC, Issue A, June, 1993. **Drawings are not to scale.** 

**Supertex inc.** does not recommend the use of its products in life support applications, and will not knowingly sell its products for use in such applications, unless it receives an adequate "product liability indemnification insurance agreement". **Supertex** does not assume responsibility for use of devices described and limits its liability to the replacement of the devices determined defective due to workmanship. No responsibility is assumed for possible omissions or inaccuracies. Circuitry and specifications are subject to change without notice. For the latest product specifications, refer to the **Supertex** website: http://www.supertex.com.

©2007 **Supertex inc.** All rights reserved. Unauthorized use or reproduction is prohibited.

Doc. #: DSPD-44PLCCPJ

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

## Microchip:

HV7022PJ-C-G HV7022DJ-C HV7022PJ-C HV7022PJ-C-G M903